

# Field Effect Transistor - N-Channel, Enhancement Mode

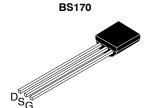
# **BS170, MMBF170**

#### **General Description**

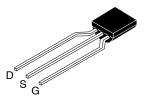
These N-Channel enhancement mode field effect transistors are produced using **onsemi**'s proprietary, high cell density, DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 500 mA DC. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

#### **Features**

- High Density Cell Design for Low R<sub>DS(ON)</sub>
- Voltage Controlled Small Signal Switch
- Rugged and Reliable
- High Saturation Current Capability
- These are Pb-Free Devices



TO-92 3 4.825x4.76 CASE 135AN

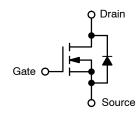


TO-92 3 4.83x4.76 LEADFORMED CASE 135AR

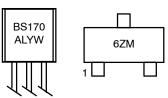
#### **MMBF170**



SOT-23 CASE 318-08



#### **MARKING DIAGRAM**



BS170, 6Z = Device Code

A = Assembly Plant Code
L = Wafer Lot Number
YW = Assembly Start Week
M = Date Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 6 of this data sheet.

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#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter		BS170	MMBF170	Unit
V <sub>DSS</sub>	Drain-Source Voltage	60		V	
$V_{DGR}$	Drain-Gate Voltage ( $R_{GS} \le 1 M\Omega$ )	60		V	
V <sub>GSS</sub>	Gate-Source Voltage	±20		V	
I <sub>D</sub>	Drain Current - Continuous - Pulsed		500	500	mA
			1200	800	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		– 55 t	o 150	°C
TL	Maximum Lead Temperature for Sofor 10 Seconds	30	00	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### **THERMAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	BS170	MMBF170	Unit
P <sub>D</sub>	Maximum Power Dissipation Derate above 25°C	830 6.6	300 2.4	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	150	417	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Type	Min	Тур	Max	Unit
OFF CHA	RACTERISTICS		•		•	•	•
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	All	60	-	_	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V	All	-	-	0.5	μΑ
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	V <sub>GS</sub> = 15 V, V <sub>DS</sub> = 0 V	All	-	-	10	nA
ON CHAR	ACTERISTICS (Note 1)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 1 \text{ mA}$	All	0.8	2.1	3	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 200 mA	All	-	1.2	5	Ω
9FS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 200 mA	BS170	-	320	-	mS
		$V_{DS} \ge 2 \ V_{DS(on)}, \ I_D = 200 \ mA$	MMBF170	-	320	_	
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$	All	-	24	40	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz	All	-	17	30	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		All	-	7	10	pF
SWITCHIN	IG CHARACTERISTICS (Note 1)						
t <sub>on</sub>	Turn-On Time	$V_{DD}$ = 25 V, $I_{D}$ = 200 mA, $V_{GS}$ = 10 V, $R_{GEN}$ = 25 $\Omega$	BS170	-	_	10	ns
		$V_{DD}$ = 25 V, $I_{D}$ = 500 mA, $V_{GS}$ = 10 V, $R_{GEN}$ = 50 $\Omega$	MMBF170	_	-	10	
t <sub>off</sub>	Turn-Off Time	$V_{DD}$ = 25 V, $I_{D}$ = 200 mA, $V_{GS}$ = 10 V, $R_{GEN}$ = 25 $\Omega$	BS170	-	-	10	ns
		$V_{DD}$ = 25 V, $I_{D}$ = 500 mA, $V_{GS}$ = 10 V, $R_{GEN}$ = 50 $\Omega$	MMBF170	-	-	10	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>1.</sup> Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

#### TYPICAL ELECTRICAL CHARACTERISTICS

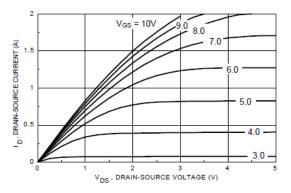


Figure 1. On-Region Characteristics

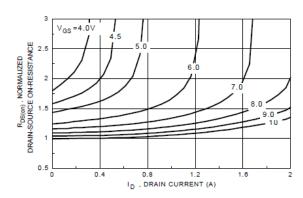


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

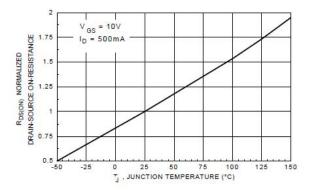


Figure 3. On–Resistance Variation with Temperature

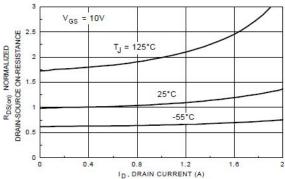


Figure 4. On-Resistance Variation with Drain Current and Temperature

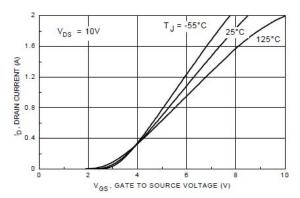


Figure 5. Transfer Characteristics

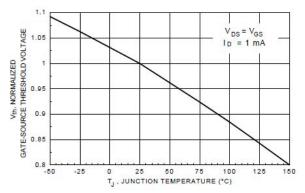


Figure 6. Gate Threshold Variation with Temperature

#### TYPICAL ELECTRICAL CHARACTERISTICS (continued)

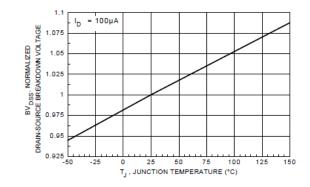


Figure 7. Breakdown Voltage Variation with Temperature

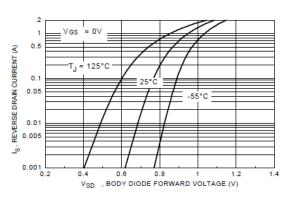


Figure 8. Body Diode Forward Voltage Variation with Current and Temperature

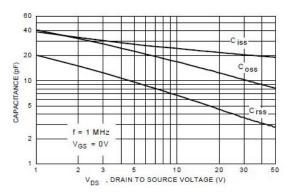


Figure 9. Capacitance Characteristics

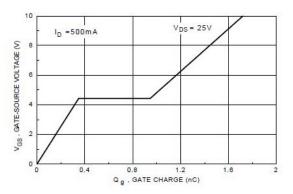


Figure 10. Gate Charge Characteristics

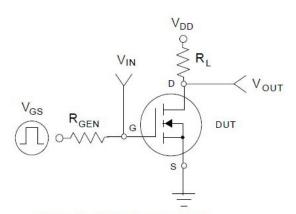


Figure 11. Switching Test Circuit

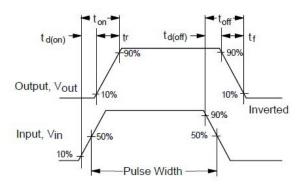


Figure 12. Switching Waveforms

#### TYPICAL ELECTRICAL CHARACTERISTICS (continued)

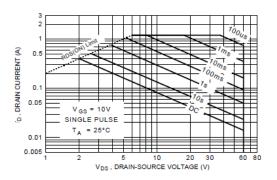


Figure 13. BS170 Maximum Safe Operating Area

Figure 14. MMBF170 Maximum Safe Operating Area

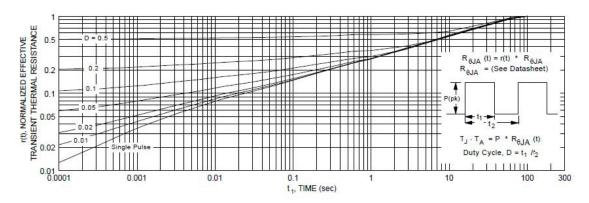


Figure 15. TO-92, BS170 Transient Thermal Response Curve

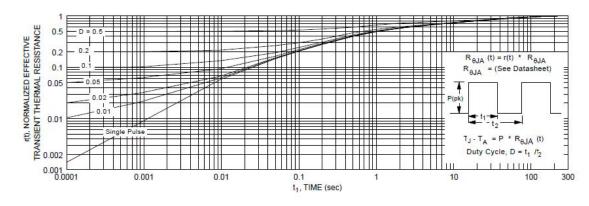


Figure 16. SOT-23, MMBF170 Transient Thermal Response Curve

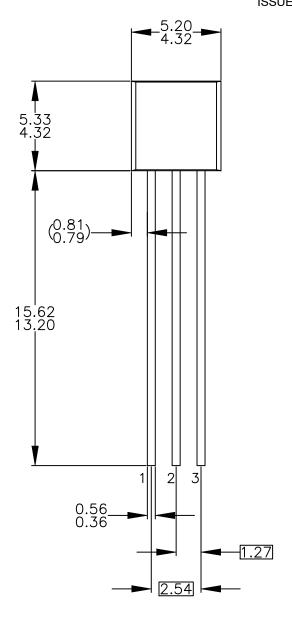
#### **ORDERING INFORMATION**

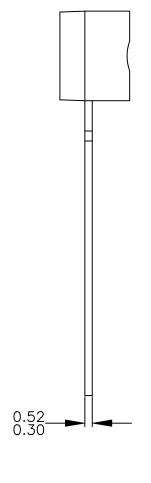
Part Number	Package	Lead Frame	Pin Array	Shipping <sup>†</sup>
BS170	TO-92 (Pb-Free)	Straight	DGS	10000 Units / Bulk
BS170-D26Z	TO-92 (Pb-Free)	Forming	DGS	2000 / Tape & Reel
BS170-D27Z	TO-92 (Pb-Free)	Forming	DGS	2000 / Tape & Reel
BS170-D74Z	TO-92 (Pb-Free)	Forming	DGS	2000 / Ammo
BS170-D75Z	TO-92 (Pb-Free)	Forming	DGS	2000 / Ammo
MMBF170	SOT-23 (Pb-Free)			3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### TO-92 3 4.825x4.76 CASE 135AN ISSUE O

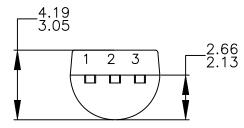
**DATE 31 JUL 2016** 





NOTES: UNLESS OTHERWISE SPECIFIED

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- ALL DIMENSIONS ARE IN MILLIMETERS.
  DRAWING CONFORMS TO ASME Y14.5M—2009.



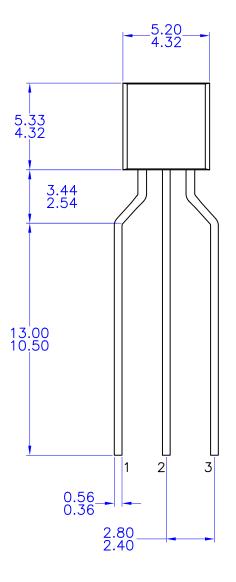
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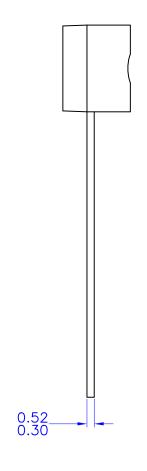
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#### TO-92 3 4.83x4.76 LEADFORMED

CASE 135AR ISSUE O

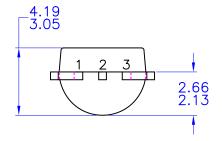
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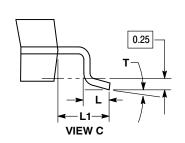


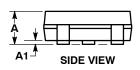
SOT-23 (TO-236) CASE 318-08 **ISSUE AS** 

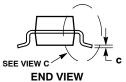
**DATE 30 JAN 2018** 

# SCALE 4:1 D - 3X b

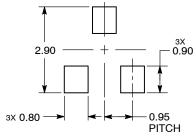
**TOP VIEW** 







#### **RECOMMENDED SOLDERING FOOTPRINT**



DIMENSIONS: MILLIMETERS

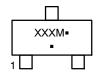
3. ANODE

#### NOTES:

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
  MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			TERS INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	O٥		100	O٥		10°

#### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE		
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE	2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE	3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT	3. CATHODE	3. SOURCE	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE				

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